

# DATA SHEET

**PCK2021**

CK00 (100/133 MHz) spread spectrum  
differential system clock generator

Product data

2001 Oct 11

File under Integrated Circuits, ICL03

CK00 (100/133 MHz) spread spectrum  
differential system clock generator

PCK2021

FEATURES

- 3.3 V operation
- Six differential CPU clock pairs
- Two PCI clocks at 33 MHz and one 3V66 clock
- Two 48 MHz clocks at 3.3 V
- One 14.318 MHz reference clock
- Power management control pins
- Host clock jitter less than 200 ps cycle-to-cycle
- Host clock skew less than 150 ps pin-to-pin
- Spread Spectrum capability
- Optimized frequency and spread spectrum performance

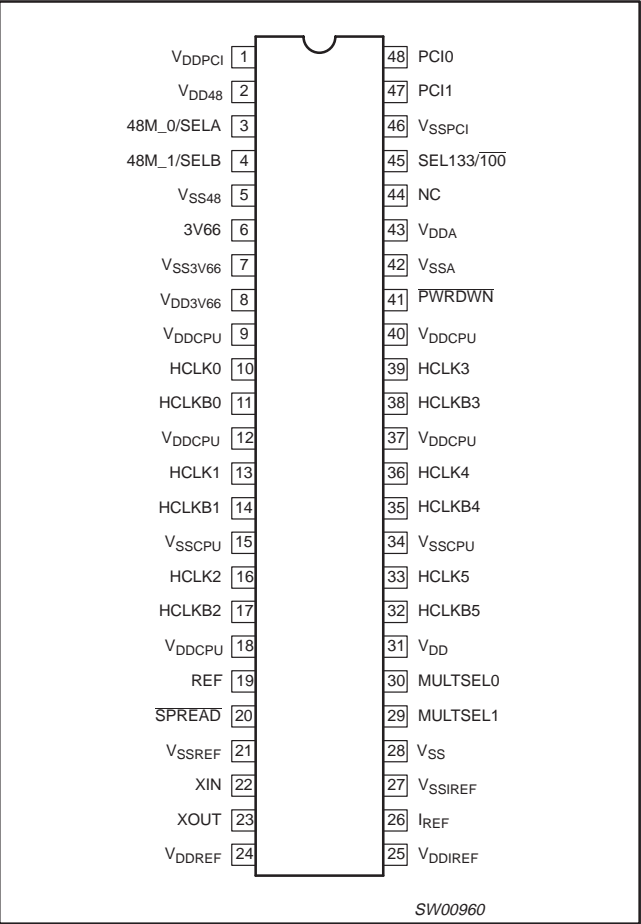
DESCRIPTION

The PCK2021 is a clock synthesizer/driver for a Pentium III™ and other similar processors.

The PCK2021 has six differential pair CPU current source outputs, two 33 MHz outputs, one 3V66 output, and two 48 MHz clocks which can be disabled on power-up, and one 3.3 V reference clock at 14.318 MHz which can also be disabled on power-up.

The part possesses a dedicated power-down input pin for power management control. This input is synchronized on chip, and ensures glitch-free output transitions. In addition, the part can be configured to disable the 48 MHz outputs for lower power operation and an increase in the performance of the functioning outputs. The REF and PCI outputs can also be disabled for the highest performance of the Host outputs.

PIN CONFIGURATION



ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DRAWING NUMBER
48-Pin Plastic TSSOP	0 to +70 °C	PCK2021DGG	SOT362-1
48-Pin Plastic SSOP	0 to +70 °C	PCK2021DL	SOT370-1

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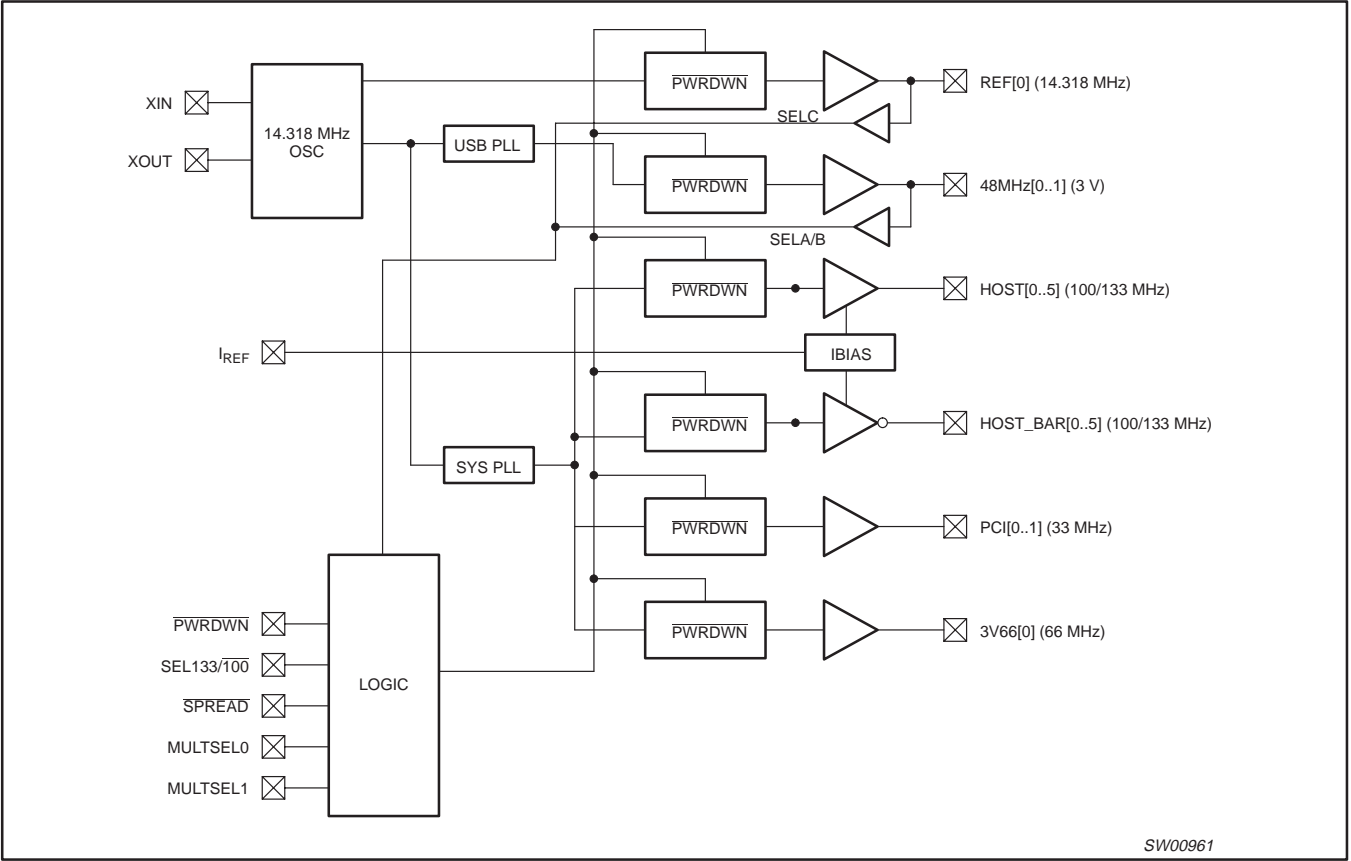
## PIN DESCRIPTION

PIN(S)	SYMBOL	FUNCTION
1, 2, 8, 9, 12, 18, 24, 25, 31, 37, 40	V <sub>DD</sub>	3.3 V power supply Pins 9, 12, and 18 supply host output pairs 0, 1, and 2. Pins 37 and 40 supply host output pairs 3, 4, and 5.
3, 4	48M_0/SELA 48M_1/SELB	3.3 V fixed 48 MHz clock outputs. During power-up pins function as latched inputs that enable SELA and SELB prior to the pins being used for output of 3 V at 48 MHz. Part must be clocked to latch data in.
6	3V66	66 MHz clock: 66 MHz reference clock
10, 11	HCLK0 HCLKB0	Host output pair 0
13, 14	HCLK1 HCLKB1	Host output pair 1
16, 17	HCLK2 HCLKB2	Host output pair 2
47, 48	PCI0 PCI1	33 MHz clocks: 33 MHz reference clocks
39, 38	HCLK3 HCLKB3	Host output pair 3
36, 35	HCLK4 HCLKB4	Host output pair 4
33, 32	HCLK5 HCLKB5	Host output pair 5
19	REF	3.3 V fixed 14.318 MHz output
20	SPREAD	Enables spread spectrum mode when held LOW on differential host outputs, 3V66 and PCI clocks. Asserts LOW.
22	XIN	Crystal input
23	XOUT	Crystal output
26	I <sub>REF</sub>	This pin controls the reference current for the host pairs. This pin requires a fixed precision resistor tied to ground in order to establish the correct current.
29, 30	MULTSEL0 MULTSEL1	Select input pin used to control the scaling of the HCLK and HCLKB output current.
41	PWRDWN	Device enters power-down mode when held LOW. Asserts LOW.
45	SEL133/100	Select input pin for enabling 133 MHz or 100 MHz CPU outputs
5, 7, 15, 21, 27, 28, 34, 46	V <sub>SS</sub>	Ground
43	V <sub>DDA</sub>	3.3 V power supply for analog circuits
42	V <sub>SSA</sub>	Ground for analog circuits

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BLOCK DIAGRAM



FUNCTION TABLE

SEL100/133	SELA	SELB	HOST	48MHz	PCI33MHz	66MHz	REFCLK
0	0	0	100 MHz	48 MHz	33.3 MHz	66.7 MHz	14.3 MHz
0	0	1	100 MHz	Disable/Low	33.3 MHz	66.7 MHz	14.3 MHz
0	1	0	100 MHz	Disable/Low	Disable/Low	66.7 MHz	Disable/Low
0	1	1	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
1	0	0	133 MHz	48 MHz	33.3 MHz	66.7 MHz	14.3 MHz
1	0	1	133 MHz	Disable/Low	33.3 MHz	66.7 MHz	14.3 MHz
1	1	0	200 MHz	48 MHz	33.3 MHz	66.7 MHz	14.3 MHz

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Table 1. Host swing select functions

MULTSEL0	MULTSEL1	BOARD IMPEDANCE	I <sub>REF</sub>	I <sub>OH</sub>	V <sub>OH</sub> @ I <sub>REF</sub> = 2.32 mA
0	0	60 Ω	R <sub>REF</sub> = 475 1% I <sub>REF</sub> = 2.32 mA	I <sub>OH</sub> = 5*I <sub>REF</sub>	0.71 V
0	0	50 Ω	R <sub>REF</sub> = 475 1% I <sub>REF</sub> = 2.32 mA	I <sub>OH</sub> = 5*I <sub>REF</sub>	0.59 V
0	1	60 Ω	R <sub>REF</sub> = 475 1% I <sub>REF</sub> = 2.32 mA	I <sub>OH</sub> = 6*I <sub>REF</sub>	0.85 V
0	1	50 Ω	R <sub>REF</sub> = 475 1% I <sub>REF</sub> = 2.32 mA	I <sub>OH</sub> = 6*I <sub>REF</sub>	0.71 V
1	0	60 Ω	R <sub>REF</sub> = 475 1% I <sub>REF</sub> = 2.32 mA	I <sub>OH</sub> = 4*I <sub>REF</sub>	0.56 V
1	0	50 Ω	R <sub>REF</sub> = 475 1% I <sub>REF</sub> = 2.32 mA	I <sub>OH</sub> = 4*I <sub>REF</sub>	0.47 V
1	1	60 Ω	R <sub>REF</sub> = 475 1% I <sub>REF</sub> = 2.32 mA	I <sub>OH</sub> = 7*I <sub>REF</sub>	0.99 V
1	1	50 Ω	R <sub>REF</sub> = 475 1% I <sub>REF</sub> = 2.32 mA	I <sub>OH</sub> = 7*I <sub>REF</sub>	0.82 V
0	0	30 Ω	R <sub>REF</sub> = 221 1% I <sub>REF</sub> = 5 mA	I <sub>OH</sub> = 5*I <sub>REF</sub>	0.75 V
0	0	25 Ω	R <sub>REF</sub> = 221 1% I <sub>REF</sub> = 5 mA	I <sub>OH</sub> = 5*I <sub>REF</sub>	0.62 V
0	1	30 Ω	R <sub>REF</sub> = 221 1% I <sub>REF</sub> = 5 mA	I <sub>OH</sub> = 6*I <sub>REF</sub>	0.90 V
0	1	25 Ω	R <sub>REF</sub> = 221 1% I <sub>REF</sub> = 5 mA	I <sub>OH</sub> = 6*I <sub>REF</sub>	0.75 V
1	0	30 Ω	R <sub>REF</sub> = 221 1% I <sub>REF</sub> = 5 mA	I <sub>OH</sub> = 4*I <sub>REF</sub>	0.60 V
1	0	25 Ω	R <sub>REF</sub> = 221 1% I <sub>REF</sub> = 5 mA	I <sub>OH</sub> = 4*I <sub>REF</sub>	0.50 V
1	1	30 Ω	R <sub>REF</sub> = 221 1% I <sub>REF</sub> = 5 mA	I <sub>OH</sub> = 7*I <sub>REF</sub>	1.05 V
1	1	25 Ω	R <sub>REF</sub> = 221 1% I <sub>REF</sub> = 5 mA	I <sub>OH</sub> = 7*I <sub>REF</sub>	0.84 V

**NOTE:**

The outputs are optimized for the configurations shown shaded.

	CONDITIONS	CONFIGURATION	LOAD	MIN.	MAX.
I <sub>OUT</sub>	V <sub>DD</sub> = 3.3 V	All combinations; see Table 1 above	Nominal test load for given configuration	−7% of I <sub>OH</sub> see Table 1 above	+7% of I <sub>OH</sub> see Table 1 above
I <sub>OUT</sub>	V <sub>DD</sub> = 3.3 V ±5%	All combinations; see Table 1 above	Nominal test load for given configuration	−12% of I <sub>OH</sub> see Table 1 above	+12% of I <sub>OH</sub> see Table 1 above

**POWER-DOWN MODE**

PWRDWN	HCLK/HCLKB	3V66	PCI	48MHz	REFCLK
Asserts LOW 0 = Active	Host = 2*I <sub>REF</sub> Host_bar = undriven	LOW	LOW	LOW	LOW

**NOTE:**

The differential outputs should have a voltage forced across them when power-down is asserted.

**SPREAD SPECTRUM FUNCTION**

SPREAD #	FUNCTION	48 MHz PLL REFCLK
1	Host, PCI, and 3V66 No Spread	No Spread
0	Host, PCI, and 3V66 spread < 0.5%	No Spread

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## ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	CONDITIONS	LIMITS		UNIT
			MIN	MAX	
$V_{DD3}$	DC 3.3 V supply		-0.5	4.6	V
$I_{IK}$	DC input diode current	$V_I < 0$	—	-50	mA
$V_I$	DC input voltage	Note 2	-0.5	$V_{DD}$	V
$I_{OK}$	DC output diode current	$V_O > V_{DD}$ or $V_O < 0$	—	±50	mA
$V_O$	DC output voltage	Note 2	-0.5	$V_{DD}+0.5$	V
$I_O$	DC output source or sink current	$V_O = 0$ to $V_{DD}$	—	±50	mA
$T_{stg}$	Storage temperature range		-65	+150	°C
$P_{tot}$	Power dissipation per package plastic medium-shrink (TSSOP)	For temperature range 0 °C to +70 °C; above +55 °C derate linearly with 11.3 mW/K	—	850	mW

### NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated under "recommended operating condition" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The input and output voltage rating may be exceeded if the input and output current ratings are observed.

## RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	LIMITS		UNIT
			MIN	MAX	
$V_{DD3}$	DC 3.3 V supply voltage		3.135	3.465	V
$AV_{DD}$	DC 3.3 V analog supply voltage		3.135	3.465	V
$C_L$	Capacitive load on:				
	3V666	1 device load, possible 2	10	30	pF
	PCI	Must meet JEDEC PCI 2.1 Spec. Requirements	10	30	pF
	48 MHz clock	1 device load	10	20	pF
	REF	1 device load	10	20	pF
$f_{ref}$	Reference frequency, oscillator normal value		14.31818	14.31818	MHz
$T_{amb}$	Operating ambient temperature range in free air		0	+70	°C

## POWER MANAGEMENT

CONDITION	<b>MAXIMUM 3.3 V SUPPLY CONSUMPTION</b> <b>MAXIMUM DISCRETE CAPACITANCE LOADS</b> $V_{DDL} = 3.465$ V <b>ALL STATIC INPUTS = <math>V_{DD3}</math> OR <math>V_{SS}</math></b>
Power-down mode (PWRDWN = 0)	60 mA
Full active 100/133 MHz	250 mA

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## DC ELECTRICAL CHARACTERISTICS

T<sub>amb</sub> = 0 to +70 °C

SYMBOL	PARAMETER	CONDITIONS			LIMITS			UNIT
		V <sub>DD</sub> (V)	OTHER		MIN	TYP	MAX	
V <sub>IH</sub>	HIGH level input voltage	3.135 to 3.465			2.0	—	V <sub>DD</sub> +0.3	V
V <sub>IL</sub>	LOW level input voltage	3.135 to 3.465			V <sub>SS</sub> -0.3	—	0.8	V
V <sub>OH3</sub>	3.3 V output HIGH voltage REF, 48M	3.135 to 3.465	I <sub>OH</sub> = -1 mA		2.0	—	—	V
V <sub>OL3</sub>	3.3 V output LOW voltage REF, 48M	3.135 to 3.465	I <sub>OH</sub> = 1 mA		—	—	0.4	V
V <sub>OHP</sub>	3.3 V output HIGH voltage 3V66/PCI	3.135 to 3.465	I <sub>OH</sub> = -1 mA		2.4	—	—	V
V <sub>OLP</sub>	3.3 V output LOW voltage 3V66/PCI	3.135 to 3.465	I <sub>OH</sub> = 1 mA		—	—	0.55	V
I <sub>OH</sub>	Output HIGH current 3V66/PCI	3.135	V <sub>OUT</sub> = 1.0 V	Type 5 12 – 55 Ω	-33	—	—	mA
		3.465	V <sub>OUT</sub> = 3.135 V		—	—	-33	mA
I <sub>OH</sub>	Output HIGH current 48 MHz, REF	3.135	V <sub>OUT</sub> = 1.0 V	Type 3 20 – 60 Ω	-29	—	—	mA
		3.465	V <sub>OUT</sub> = 3.135 V		—	—	-23	mA
I <sub>OH</sub>	Output HIGH current HOST/HOST_BAR	3.135 to 3.465	0.66 V	Type X1	11	—	—	mA
			0.76 V		—	—	12.7	mA
I <sub>OL</sub>	Output LOW current 3V66/PCI	3.135	V <sub>OUT</sub> = 1.95 V	Type 5 12 – 55 Ω	30	—	—	mA
		3.465	V <sub>OUT</sub> = 0.4 V		—	—	38	mA
I <sub>OL</sub>	Output LOW current 48 MHz, REF	3.135	V <sub>OUT</sub> = 1.95 V	Type 3 20 – 60 Ω	29	—	—	mA
		3.465	V <sub>OUT</sub> = 0.4 V		—	—	27	mA
V <sub>OL</sub>	HOST/HOST_BAR	V <sub>SS</sub> = 0 V	R <sub>S</sub> = 33.2 Ω R <sub>P</sub> = 49.9 Ω	Type X1	—	—	0.05	V
±I <sub>I</sub>	Input leakage current	3.465	0 < V <sub>IN</sub> < V <sub>DD3</sub>		-50	—	50	μA
±I <sub>OZ</sub>	3-State output OFF-State current	3.465	V <sub>OUT</sub> = V <sub>DD</sub> or GND	I <sub>O</sub> = 0	—	—	10 <sup>1</sup>	μA
C <sub>in</sub>	Input pin capacitance				—	—	5	pF
C <sub>out</sub>	Output pin capacitance				—	—	6	pF
C <sub>xtal</sub>	Crystal input capacitance				13.5	—	22.5	pF

### NOTE:

- REF output limit is 100 μA.

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## AC ELECTRICAL CHARACTERISTICS

 $V_{DD3} = 3.3 \text{ V} \pm 5\%$ ;  $f_{\text{crystal}} = 14.31818 \text{ MHz}$ 

### Host clock outputs

 $T_{\text{amb}} = 0 \text{ to } +70 \text{ }^{\circ}\text{C}$ ; see Figure 1 for waveforms and Figure 6 for test setup.

SYMBOL	PARAMETER	LIMITS				UNITS	NOTES
		133 MHz MODE		100 MHz MODE			
		MIN	MAX	MIN	MAX		
t <sub>PERIOD</sub>	HOST CLK average period	7.5	7.65	10.0	10.2	ns	11, 14, 19
Abs Min Period	Absolute minimum host clock period	7.35	N/A	9.85	N/A	ns	11, 14, 19
t <sub>RISE</sub>	HOST CLK rise time	175	700	175	700	ns	11, 15, 19
t <sub>FALL</sub>	HOST CLK fall time	175	700	175	700	ps	11, 15, 19
t <sub>JITTER</sub>	HOST_CLK cycle-to-cycle jitter	—	150	—	150	ps	11, 12, 14, 19
DUTY CYCLE	Output duty cycle	45	55	45	55	%	11, 14, 19
t <sub>SKEW</sub>	HOST CLK pin-to-pin skew	—	150	—	110	ps	11, 14, 19
V <sub>crossover</sub>		45% V <sub>OH</sub>	55% V <sub>OH</sub>	45% V <sub>OH</sub>	55% V <sub>OH</sub>	V	11, 14, 19

REFER TO NOTES ON PAGE 10.

### USB clock output, 48MHz

 $T_{\text{amb}} = 0 \text{ to } +70 \text{ }^{\circ}\text{C}$ ; lump capacitance test load = 20 pF

SYMBOL	PARAMETER	LIMITS		UNITS	NOTES
		48 MHz MODE			
		MIN	MAX		
f	Frequency, actual	48.000		MHz	4
f <sub>D</sub>	Deviation from 48 MHz	−0	+167	ppm	4
t <sub>RISE</sub>	3V48MHZCLK rise time	1.0	4.0	ns	8, 19
t <sub>FALL</sub>	3V48MHZCLK fall time	1.0	4.0	ns	8, 19
t <sub>JITTER</sub>	Cycle-to-cycle jitter	—	450	ps	17, 19
DUTY CYCLE	Output duty cycle	45	55	%	17, 19

REFER TO NOTES ON PAGE 10.

### PCI Outputs

 $T_{\text{amb}} = 0 \text{ to } +70 \text{ }^{\circ}\text{C}$ 

SYMBOL	PARAMETER	LIMITS		UNITS	NOTES
		MIN	MAX		
$t_{\text{PERIOD}}$	Period	30.0	N/A	ns	2, 3, 9, 19
$t_{\text{HIGH}}$	High time	12.0	N/A	ns	5, 10, 19
$t_{\text{LOW}}$	Low time	12.0	N/A	ns	6, 10, 19
$t_{\text{RISE}}$	Rise time	0.5	2.0	ns	8, 19
$t_{\text{FALL}}$	Fall time	0.5	2.0	ns	17, 19
DUTY CYCLE	Duty cycle	45	55	%	17, 19
$t_{\text{JITTER}}$	Cycle-to-cycle jitter	—	200	ps	17, 19
$t_{\text{SKEW}}$	Pin-to-pin skew	—	150	ps	2

REFER TO NOTES ON PAGE 10.



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## 3V66 Outputs

T<sub>amb</sub> = 0 to +70 °C

SYMBOL	PARAMETER	LIMITS		UNITS	NOTES
		MIN	MAX		
t <sub>PERIOD</sub>	Period	15.0	16.0	ns	2, 3, 9, 19
t <sub>HIGH</sub>	High time	5.25	N/A	ns	5, 10, 19
t <sub>LOW</sub>	Low time	5.05	N/A	ns	6, 10, 19
t <sub>RISE</sub>	Rise time	0.5	2.0	ns	8, 19
t <sub>FALL</sub>	Fall time	0.5	2.0	ns	17, 19
DUTY CYCLE	Duty cycle	45	55	%	17, 19
t <sub>JITTER</sub>	Cycle-to-cycle jitter	—	400	ps	17, 19

REFER TO NOTES ON PAGE 10.

## REF clock output

T<sub>amb</sub> = 0 to +70 °C; lump capacitance test load = 20 pF

SYMBOL	PARAMETER	LIMITS		UNITS	NOTES
		48 MHz MODE			
		MIN	MAX		
f	Frequency, actual	14.318		MHz	16, 19
t <sub>JITTER</sub>	Cycle-to-cycle jitter	—	300	ps	17, 19
DUTY CYCLE	Output duty cycle	45	55	%	17, 19

REFER TO NOTES ON PAGE 10.

## All outputs

T<sub>amb</sub> = 0 to +70 °C

SYMBOL	PARAMETER	LIMITS				UNITS	NOTES
		133 MHz MODE		100 MHz MODE			
		MIN	MAX	MIN	MAX		
t <sub>PZL</sub> , t <sub>PZH</sub>	Output enable delay (all outputs)	1.0	10.0	1.0	10.0	ns	19
t <sub>PZL</sub> , t <sub>PZH</sub>	Output disable delay (all outputs)	1.0	10.0	1.0	10.0	ns	19
t <sub>STABLE</sub>	All clock stabilization from power-up	—	3	—	3	ms	7, 19

REFER TO NOTES ON PAGE 10.

# CK00 (100/133 MHz) spread spectrum differential system clock generator

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## Group offset limits

GROUP	OFFSET	MEASUREMENT LOADS (LUMPED)	MEASUREMENT POINTS	NOTES
3V66 to PCI	0–500 ps, 3V66 leads	30 pF	1.5 V	18, 19

## NOTES TO THE AC TABLES:

- Output drivers must have monotonic rise/fall times through the specified  $V_{OL}/V_{OH}$  levels.
- Period, jitter, offset, and skew measured on rising edge at 1.5 V for 3.3 V clocks.
- PCI is a fixed 33 MHz and 3V66 is a fixed 66 MHz.
- Frequency accuracy of 48 MHz must be +167 ppm to match USB default.
- $t_{HIGH}$  is measured at 2.4 V for 3.3 V outputs, as shown in Figure 7.
- $t_{LOW}$  is measured at 0.4 V for all outputs as shown in Figure 7.
- the time is specified from when  $V_{DDQ}$  achieves its normal operating level (typical condition  $V_{DDQ} = 3.3$  V) until the frequency output is stable and operating within specification.
- $t_{RISE}$  and  $t_{FALL}$  are measured as a transition through the threshold region  $V_{OL} = 0.4$  V and  $V_{OH} = 2.4$  V (1 mA) JEDEC specification.
- The average period over any 1  $\mu$ s period of time must be greater than the minimum specified period.
- Calculated at minimum edge rate (1 V/ns) to guarantee 45–55% duty cycle. Pulse width is required to be wider at faster edge rate to ensure duty specification is met.
- Test load is  $R_S = 33.2 \Omega$ ,  $R_P = 49.9 \Omega$ .
- Must be guaranteed in a realistic system environment.
- Configured for  $V_{OH} = 0.71$  V in a 50  $\Omega$  environment.
- Measured at crossing points.
- Measured at 20% to 80%.
- Frequency generated by crystal oscillator
- Voltage measure point ( $V_M = 1.5$  V).
- All offsets are to be measured at rising edges.
- Parameters are guaranteed by design.

# CK00 (100/133 MHz) spread spectrum differential system clock generator

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## AC WAVEFORMS

$V_M = 1.25 \text{ V @ } V_{DDL} \text{ and } 1.5 \text{ V @ } V_{DD3}$   
 $V_X = V_{OL} + 0.3 \text{ V}$   
 $V_Y = V_{OH} - 0.3 \text{ V}$   
 $V_{OL}$  and  $V_{OH}$  are the typical output voltage drop that occur with the output load.

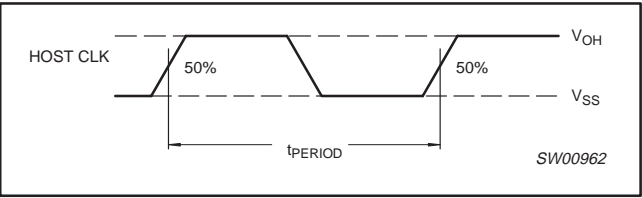


Figure 1. HOST CLOCK

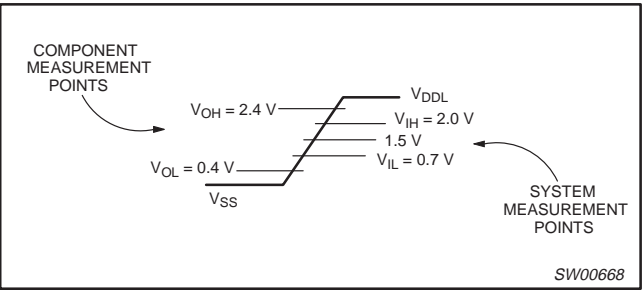


Figure 2. 3.3 V clock waveforms

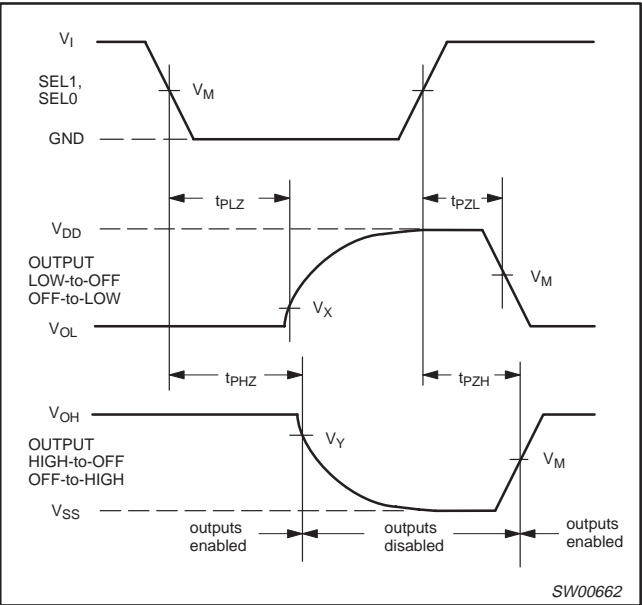


Figure 3. State enable and disable times

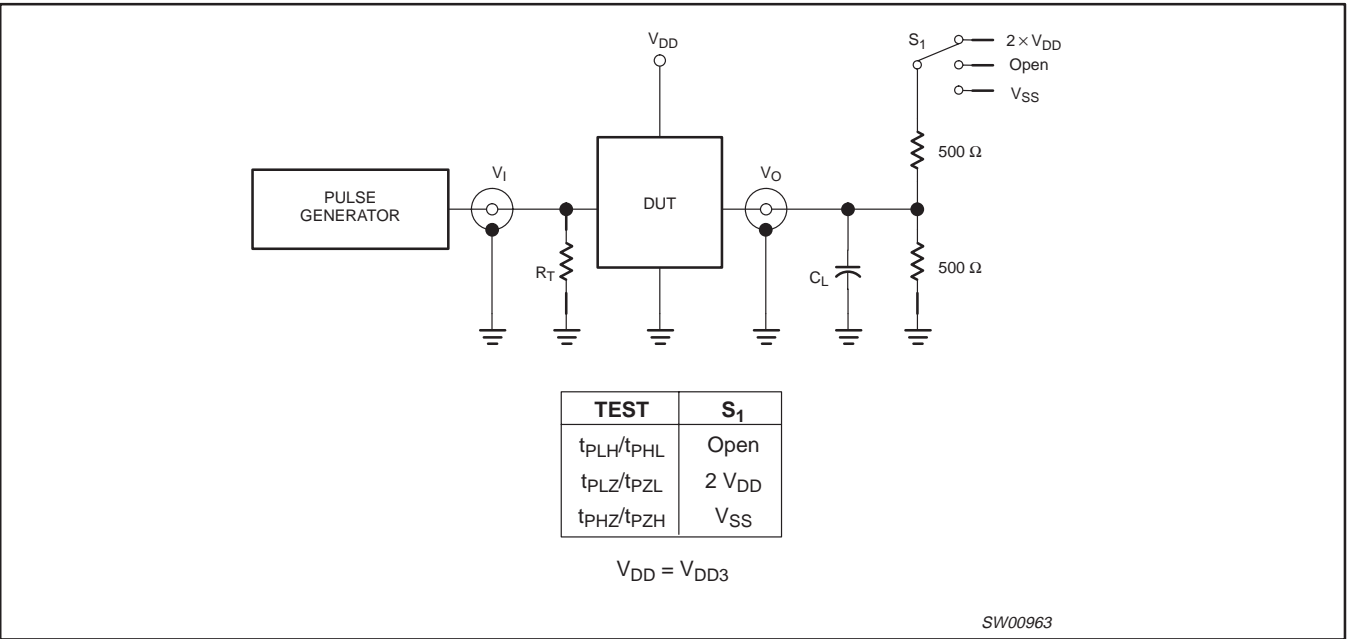


Figure 4. Load circuitry for switching times

# CK00 (100/133 MHz) spread spectrum differential system clock generator

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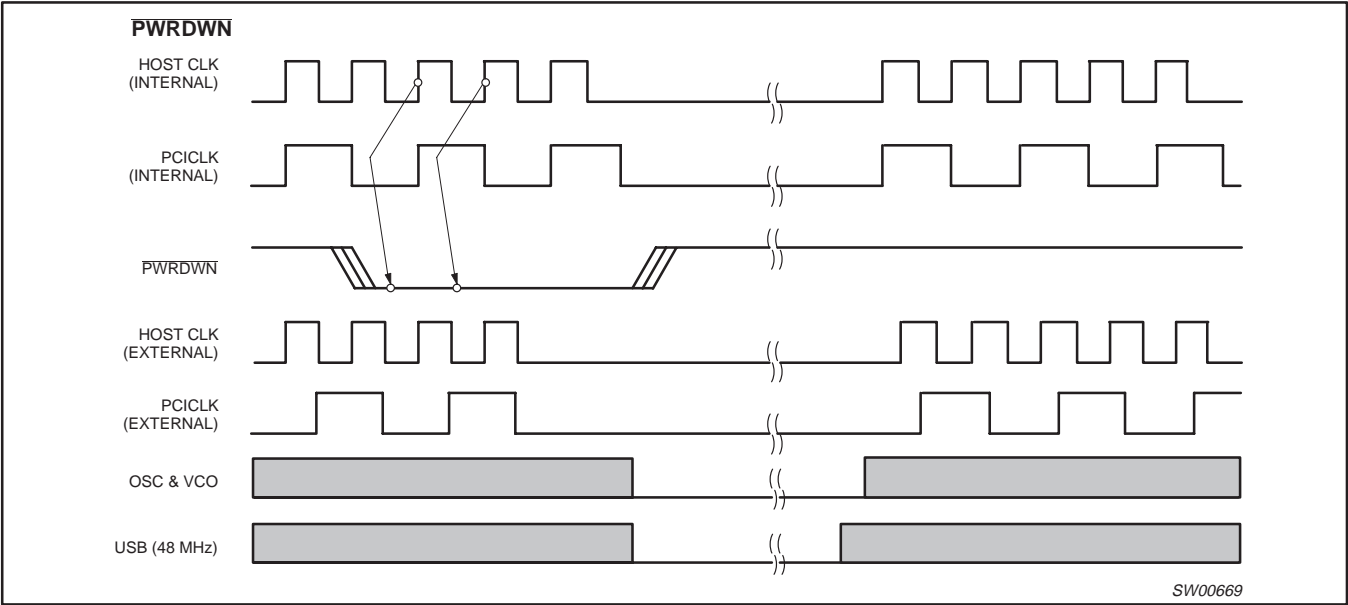


Figure 5. Power management

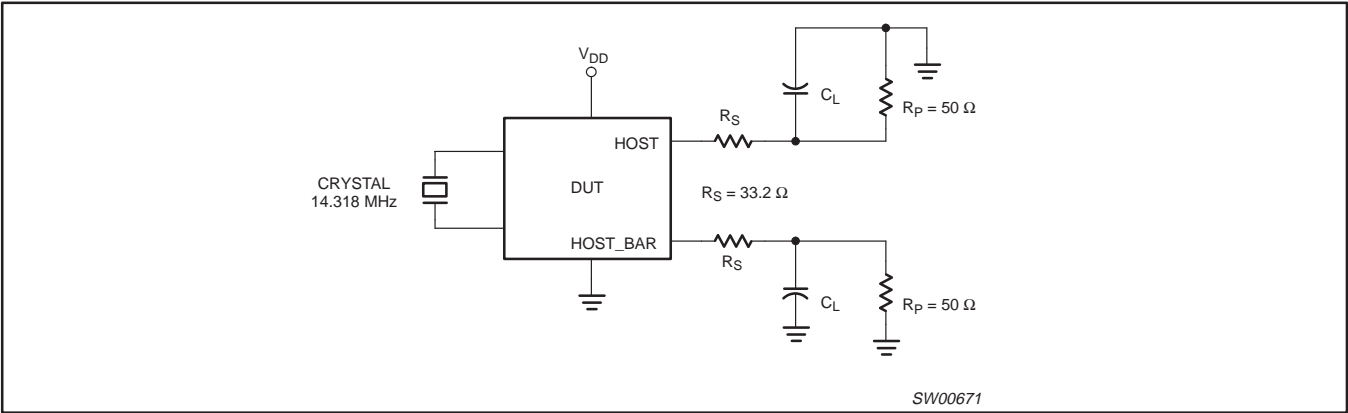


Figure 6. HOST CLOCK measurements

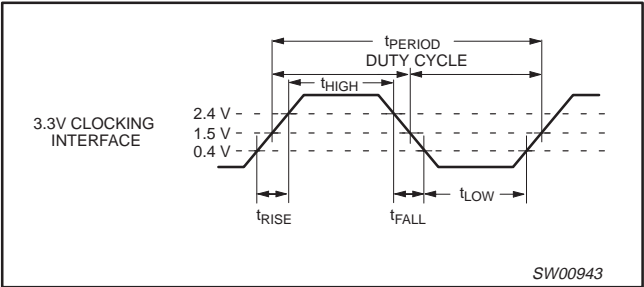


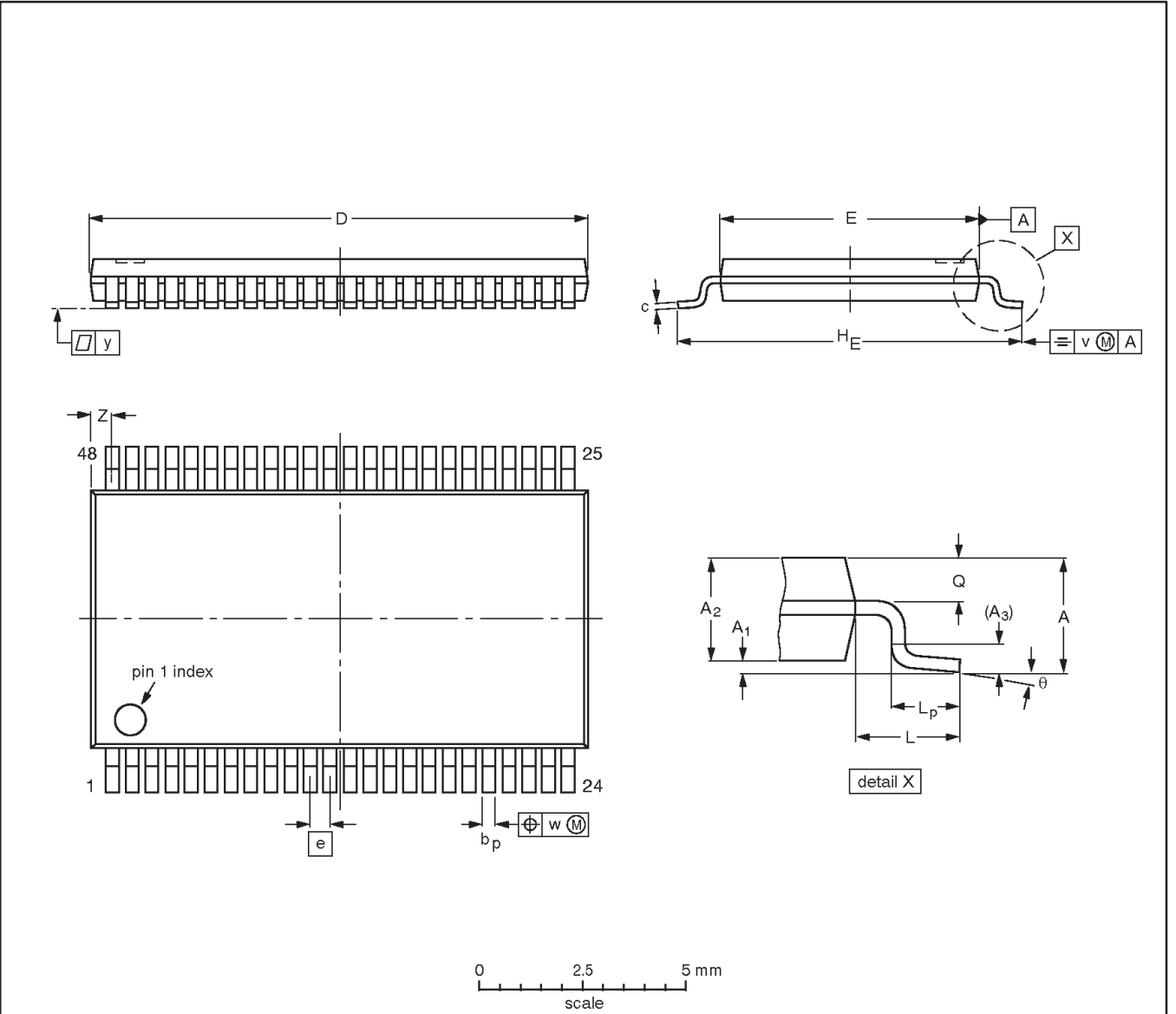
Figure 7. 3.3 V clock waveforms

CK00 (100/133 MHz) spread spectrum differential system clock generator

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TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1



DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(2)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	12.6 12.4	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.8 0.4	8° 0°

- Notes
- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
  - 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

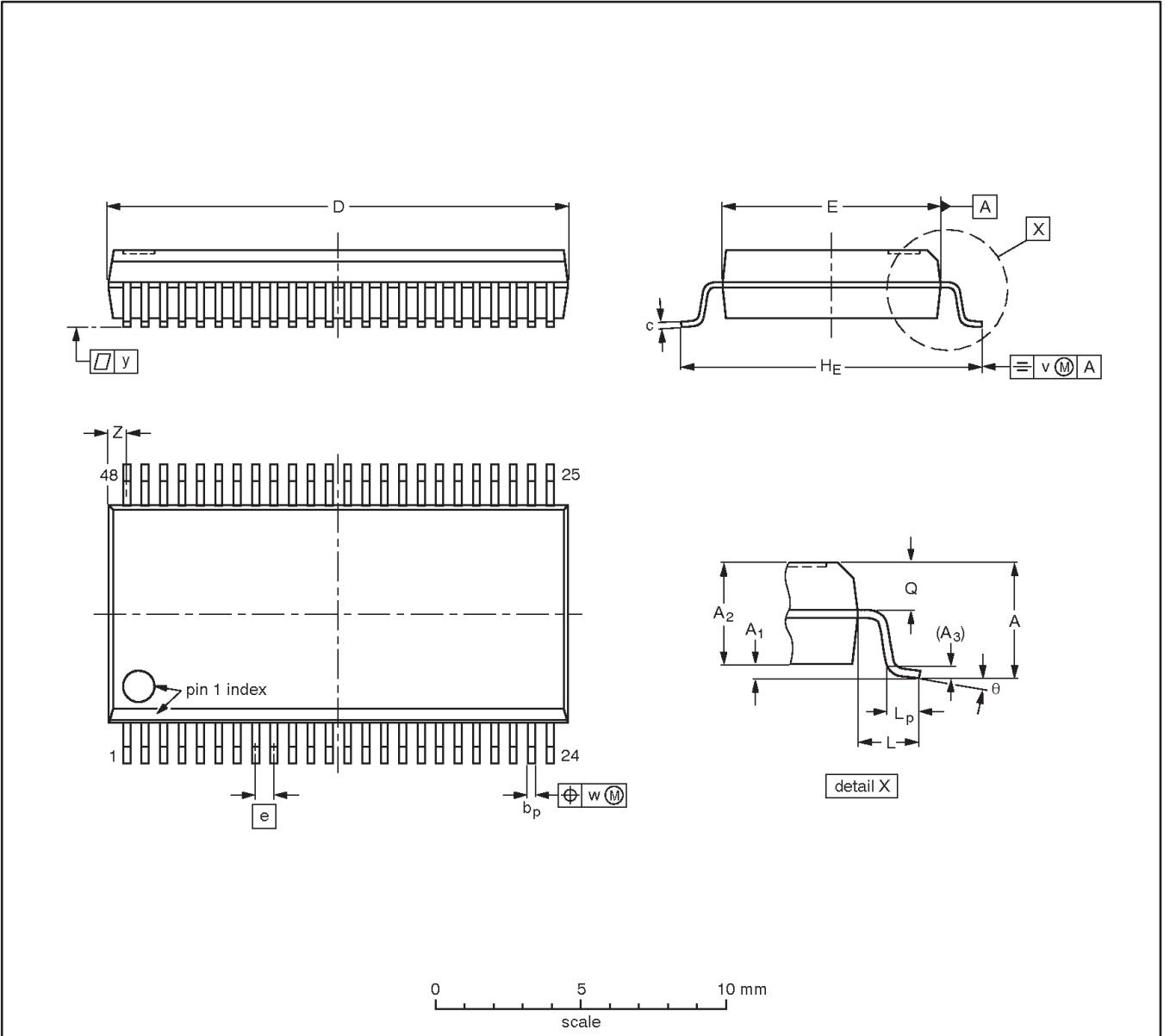
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT362-1		MO-153				-95-02-10 99-12-27

CK00 (100/133 MHz) spread spectrum differential system clock generator

PCK2021

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	16.00 15.75	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

**Note**  
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT370-1		MO-118				95-02-04 99-12-27

# CK00 (100/133 MHz) spread spectrum differential system clock generator

PCK2021

## Data sheet status

Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

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**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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## Contact information

For additional information please visit

<http://www.semiconductors.philips.com>. Fax: +31 40 27 24825

For sales offices addresses send e-mail to:

[sales.addresses@www.semiconductors.philips.com](mailto:sales.addresses@www.semiconductors.philips.com)

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